July 2014



FDMA1025P Dual P-Channel PowerTrench[®] MOSFET

–**20V**, –**3.1A**, **155m**Ω

Features

- Max $r_{DS(on)}$ = 155m Ω at V_{GS} = -4.5V, I_D = -3.1A
- Max r_{DS(on)} = 220mΩ at V_{GS} = -2.5V, I_D = -2.3A
- Low profile 0.8mm maximum in the new package MicroFET 2X2 mm
- RoHS Compliant
- Free from halogenated compounds and antimony oxides



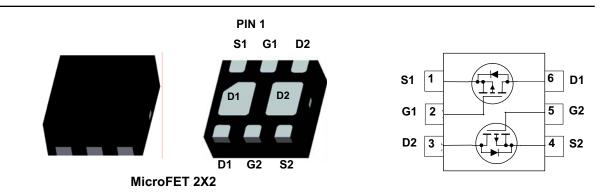
General Description

This device is designed specifically as a single package solution for the battery charge switch in cellular handset and other ultra portable applications. It features two independent P-Channel MOSFETs with low on-state resistance for minimum conduction losses. When connected in the typical common source configuration, bi-directional current flow is possible.

The MicroFET 2X2 package offers exceptional thermal performance for its physical size and well suited to linear mode applications.



DC - DC Conversion



MOSFET Maximum Ratings T_A = 25°C unless otherwise noted

Symbol	Parameter		Ratings	Units	
V _{DS}	Drain to Source Voltage		-20	V	
V _{GS}	Gate to Source Voltage		±12	V	
I _D	Drain Current -Continuous	(Note 1a)	-3.1	_	
	-Pulsed		-6	A	
P _D	Power Dissipation for Single Operation	(Note 1a)	1.4	w	
	Power Dissipation	(Note 1b)	0.7		
T _J , T _{STG}	Operating and Storage Junction Temperature Range		-55 to +150	°C	

Thermal Characteristics

R_{\thetaJA}	Thermal Resistance Single Operation, Junction to Ambient	(Note 1a)	86	
R_{\thetaJA}	Thermal Resistance Single Operation, Junction to Ambient	(Note 1b)	173	∘c/w
$R_{\theta JA}$	Thermal Resistance Dual Operation, Junction to Ambient	(Note 1c)	69	C/VV
R_{\thetaJA}	Thermal Resistance Dual Operation, Junction to Ambient	(Note 1d)	151	

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
025	FDMA1025P	MicroFET 2X2	7"	8mm	3000 units

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	Test Conditions		Min	Тур	Max	Units	
acteristics							
Drain to Source Breakdown Voltage	$I_{D} = -250 \mu A$, $V_{GS} = 0V$		-20			V	
Breakdown Voltage Temperature				14		mV/°C	
Coefficient	$I_D = -250\mu A$, referenced to 25°C			14		IIIV/ C	
Zero Gate Voltage Drain Current	V _{DS} = -16V,				-1		
	V _{GS} = 0V	T _J = 125°C			-100	μΑ	
Gate to Source Leakage Current	V_{GS} = ±12V, V_{DS}	= 0V			±100	nA	
octeristics							
Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = -250 \mu A$		-0.4	-0.9	-1.5	V	
Gate to Source Threshold Voltage				2.0		mV/°C	
Temperature Coefficient				-5.0			
				88		mΩ	
Drain to Source On Resistance							
					220	<u> </u>	
Forward Transconductance	$V_{DS} = -5V, I_{D} = -$	3.1A		6.2		S	
Characteristics							
Input Capacitance	V _{DS} = -10V, V _{GS} = 0V, f = 1MHz			340	450	pF	
Output Capacitance				80	105	pF	
Reverse Transfer Capacitance				45	70	pF	
g Characteristics							
Turn-On Delay Time				5	10	ns	
Rise Time	$V_{DD} = -10V, I_D = -3.1A$ $-V_{GS} = -4.5V, R_{GEN} = 6\Omega$			14	26	ns	
Turn-Off Delay Time				13	24	ns	
Fall Time				8	16	ns	
Total Gate Charge at 4.5V	$V_{GS} = 0V$ to $-4.5V$	$V_{DD} = -10V$		3.4	4.8	nC	
Gate to Source Gate Charge		I _D = -3.1A		0.8		nC	
Gate to Drain "Miller" Charge				1.0		nC	
urce Diode Characteristics					•		
Maximum Continuous Source-Drain Diode	n Diode Forward				-1.1	Α	
Source to Drain Diode Forward Voltage	$V_{GS} = 0V, I_S = -1.1A$ (Note 2)			-0.8	-1.2	V	
Reverse Recovery Time				17	26	ns	
Reverse Recovery Charge	- I _F = -3.1A, di/dt = 100A/μs			10	15	nC	
	Drain to Source Breakdown Voltage Breakdown Voltage Temperature Coefficient Zero Gate Voltage Drain Current Gate to Source Leakage Current cteristics Gate to Source Threshold Voltage Gate to Source Threshold Voltage Temperature Coefficient Drain to Source On Resistance Forward Transconductance Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance gCharacteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge at 4.5V Gate to Source Gate Charge Gate to Drain "Miller" Charge Jurce Diode Characteristics Maximum Continuous Source-Drain Diode Source to Drain Diode Forward Voltage Reverse Recovery Time	Drain to Source Breakdown Voltage $I_D = -250\mu A, V_{GS}$ Breakdown Voltage Temperature Coefficient $I_D = -250\mu A, referZero Gate Voltage Drain CurrentV_{DS} = -16V, V_{GS} = 0VGate to Source Leakage CurrentV_{GS} = 0VGate to Source Threshold VoltageV_{GS} = V_{DS}, I_D = -250\mu A, referGate to Source Threshold VoltageI_D = -250\mu A, referTemperature CoefficientI_D = -250\mu A, referDrain to Source On ResistanceV_{GS} = -4.5V, I_D = -250\mu A, referDrain to Source On ResistanceV_{GS} = -4.5V, I_D = -250\mu A, referPorward TransconductanceV_{DS} = -5V, I_D = -250\mu A, referOutput CapacitanceV_{DS} = -4.5V, I_D = -250\mu A, referOutput CapacitanceV_{DS} = -4.5V, I_D = -250\mu A, referOutput CapacitanceV_{DS} = -10V, V_{GS} = -10V, V_{GS} = -10V, V_{GS} = -5V, I_D = -250\mu A, referTurn-On Delay TimeV_{DS} = -10V, V_{GS} = 0V = -10V, V_{GS} = -10V, V_{GS} = 0V = -10V, V_{GS} = -10V, V_{GS} = 0V = -10V, V_{GS} = 0V = -10V, V_{GS} = -10V, V_{GS} = 0V = -10V, V_{GS} = 0V = -10V, V_{GS} = -10V, V_{GS} = -10V, V_{GS} = 0V = -10V, V_{GS} = 0V = -10V, V_{GS} = -10V, V_{GS} = 0V = -10V, V_{GS} = 0$	Drain to Source Breakdown VoltageID $= -250\mu$ A, VGS = 0VBreakdown Voltage Temperature CoefficientID $= -250\mu$ A, referenced to 25°CZero Gate Voltage Drain CurrentVDS $= -16V$, VGS = 0VTJ = 125°CGate to Source Leakage CurrentVGS = $\pm 12V$, VDS = 0VVCcteristicsGate to Source Threshold Voltage Temperature CoefficientVGS = VDS, ID = -250\muADrain to Source On ResistanceID $= -250\mu$ A, referenced to 25°CForward TransconductanceVGS = -4.5V, ID = -3.1AVGS = -4.5V, ID = -3.1ACharacteristicsInput Capacitance 	$ \begin{array}{ c c c c c } \hline Drain to Source Breakdown Voltage & I_D = -250\mu A, V_{GS} = 0V & -20 \\ \hline Breakdown Voltage Temperature Coefficient & I_D = -250\mu A, referenced to 25°C & V_{DS} = -16V, \\ \hline V_{DS} = -16V, & V_{GS} = 0V & T_J = 125°C & \\ \hline Gate to Source Leakage Current & V_{GS} = ±12V, V_{DS} = 0V & \\ \hline \end{tabular} $	$ \begin{array}{ c c c c c } \hline Drain to Source Breakdown Voltage & I_D = -250 \mu A, V_{GS} = 0V & -20 \\ \hline Preakdown Voltage Temperature Coefficient & I_D = -250 \mu A, referenced to 25°C & 14 \\ \hline I_D = -250 \mu A, referenced to 25°C & 14 \\ \hline V_{DS} = -16V, & T_J = 125°C & 0 \\ \hline Gate to Source Leakage Current & V_{GS} = 12V, V_{DS} = 0V & 0 \\ \hline Cteristics & & & & & & & & & & & & & & & & & & &$	$\begin{array}{ c c c c c c } \hline \begin{tabular}{ c c c c c } \hline \begin{tabular}{ c c c c c } \hline \begin{tabular}{ c c c c c } \hline \begin{tabular}{ c c c c } \hline \begin{tabular}{ c c c c c } \hline \begin{tabular}{ c c c c c } \hline \begin{tabular}{ c c c c c c } \hline \begin{tabular}{ c c c c c c } \hline \begin{tabular}{ c c c c c c c } \hline \begin{tabular}{ c c c c c c c } \hline \begin{tabular}{ c c c c c c c c } \hline \begin{tabular}{ c c c c c c c c c c c c c c c c c c c$	

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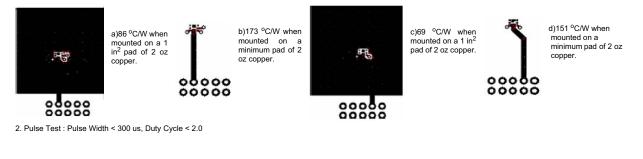
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Notes:

1. R_{0JA} is determined with the device mounted on a 1 in² oz. copper pad on a 1.5 x 1.5 in. board of FR-4 material. R_{0JC} is guaranteed by design while R_{0JA} is determined by the (a) R_{0JA} = 66 °C/W when mounted on a 1 in² pad of 2 oz copper, 1.5 " x 1.5 " x 0.062 " thick PCB. For single operation.

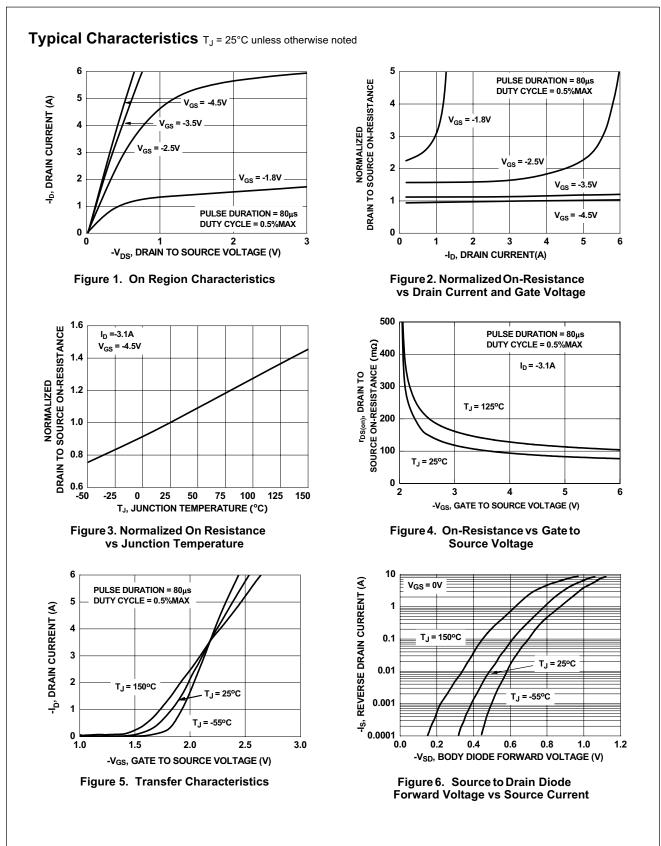
(b) $R_{\theta JA}$ = 173 °C/W when mounted on a minimum pad of 2 oz copper. For single operation.

(c) R_{0JA} = 69 °C/W when mounted on a 1 in² pad of 2 oz copper, 1.5 " x 1.5 " x 0.062 " thick PCB. For dual operation. (d) R_{0JA} = 151 °C/W when mounted on a minimum pad of 2 oz copper. For dual operation.



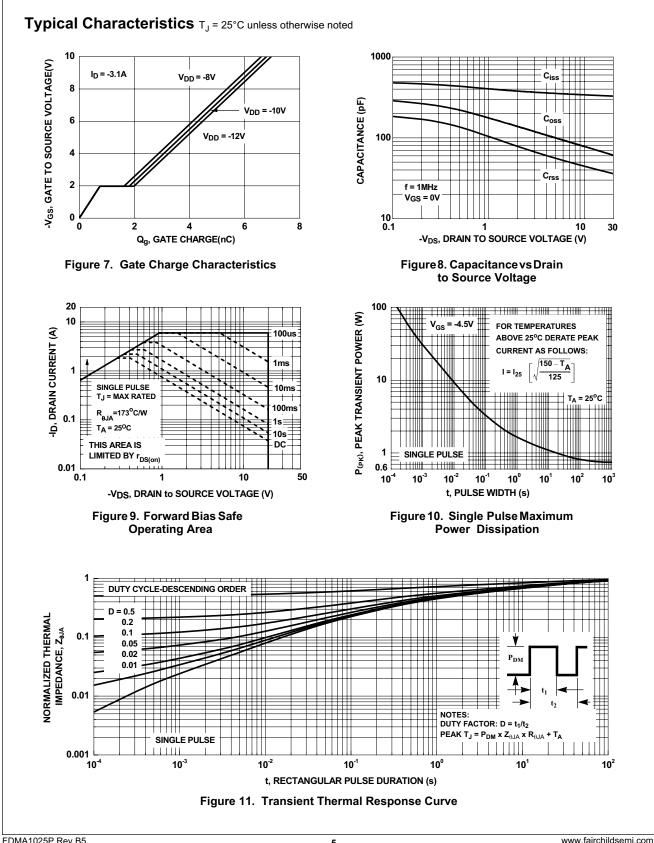
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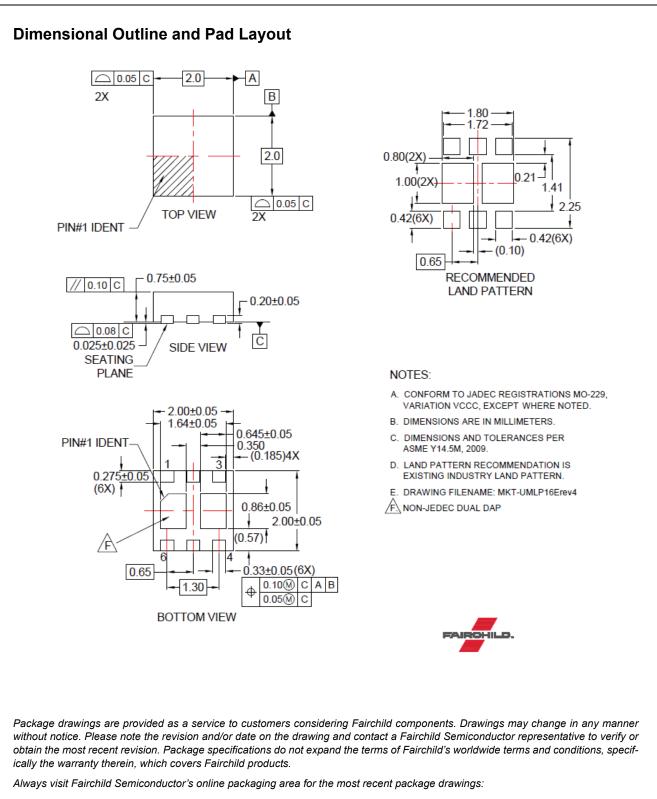
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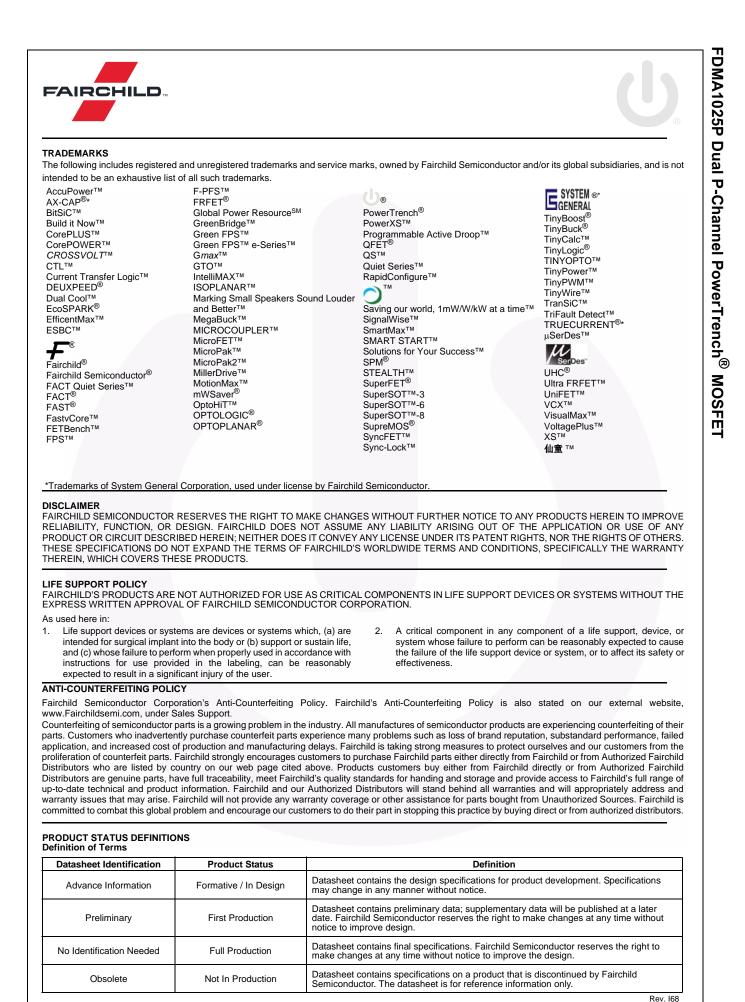
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